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(12) **United States Design Patent**  
**Abbondanzio et al.**

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(54) **DISPENSER HOUSING**

239/55, 56, 326; D26/14, 17, 98, 9, 22, 24;  
D11/131.1; D7/509, 522, 524, 537

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See application file for complete search history.

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*Primary Examiner* — Sandra Snapp

(57) **CLAIM**

The ornamental design for a dispenser housing, as shown and described.

**DESCRIPTION**

FIG. 1 is an isometric view of a top, front, and right side of an ornamental design for a dispenser housing; FIG. 2 is a front elevational view of the housing of FIG. 1; FIG. 3 is a rear elevational view of the housing of FIG. 1; FIG. 4 is a right side elevational view of the housing of FIG. 1; FIG. 5 is a left side elevational view of the housing of FIG. 1; FIG. 6 is a top plan view of the housing of FIG. 1; FIG. 7 is a bottom plan view of the housing of FIG. 1; and, FIG. 8 is an alternative embodiment of the top plan view of FIG. 6.

The broken line showing of the subject matter shown above is for the purpose of depicting environmental structure only and forms no part of the claimed design.

**1 Claim, 5 Drawing Sheets**

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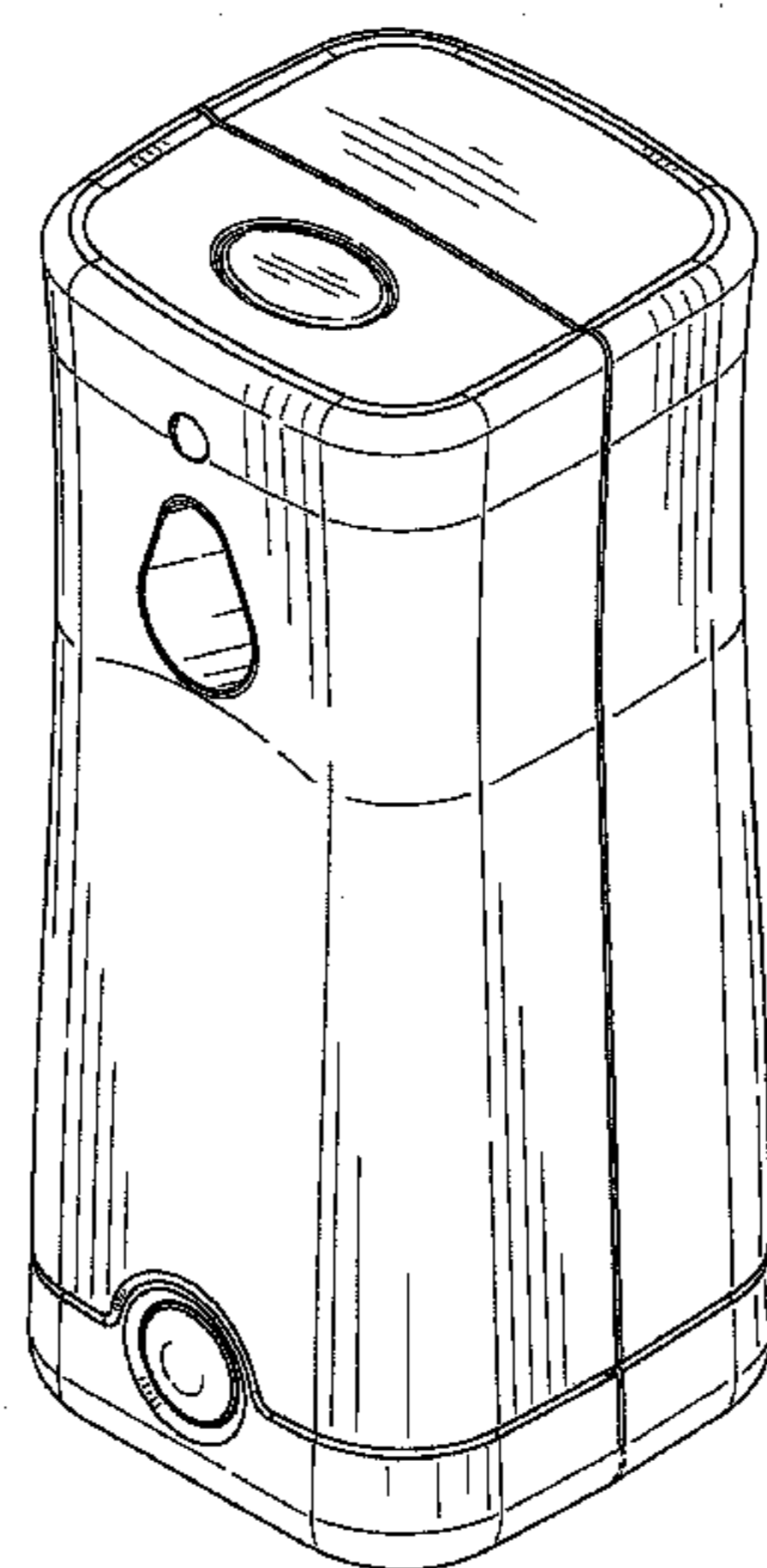
**Related U.S. Application Data**

(62) Division of application No. 29/433,647, filed on Oct. 2, 2012, now Pat. No. Des. 685,075, which is a division of application No. 29/383,794, filed on Jan. 21, 2011, now Pat. No. Des. 672,858, which is a division of application No. 29/359,828, filed on Apr. 15, 2010, now Pat. No. Des. 634,415.

(51) **LOC (9) Cl.** ..... **28-99**

(52) **U.S. Cl.**  
USPC ..... **D23/366**

(58) **Field of Classification Search**  
USPC ..... D23/355-369; D28/5, 6; 261/DIG. 17, 261/DIG. 42, DIG. 65, DIG. 88, DIG. 89; 392/386, 390, 394, 395; 239/34, 44, 53,



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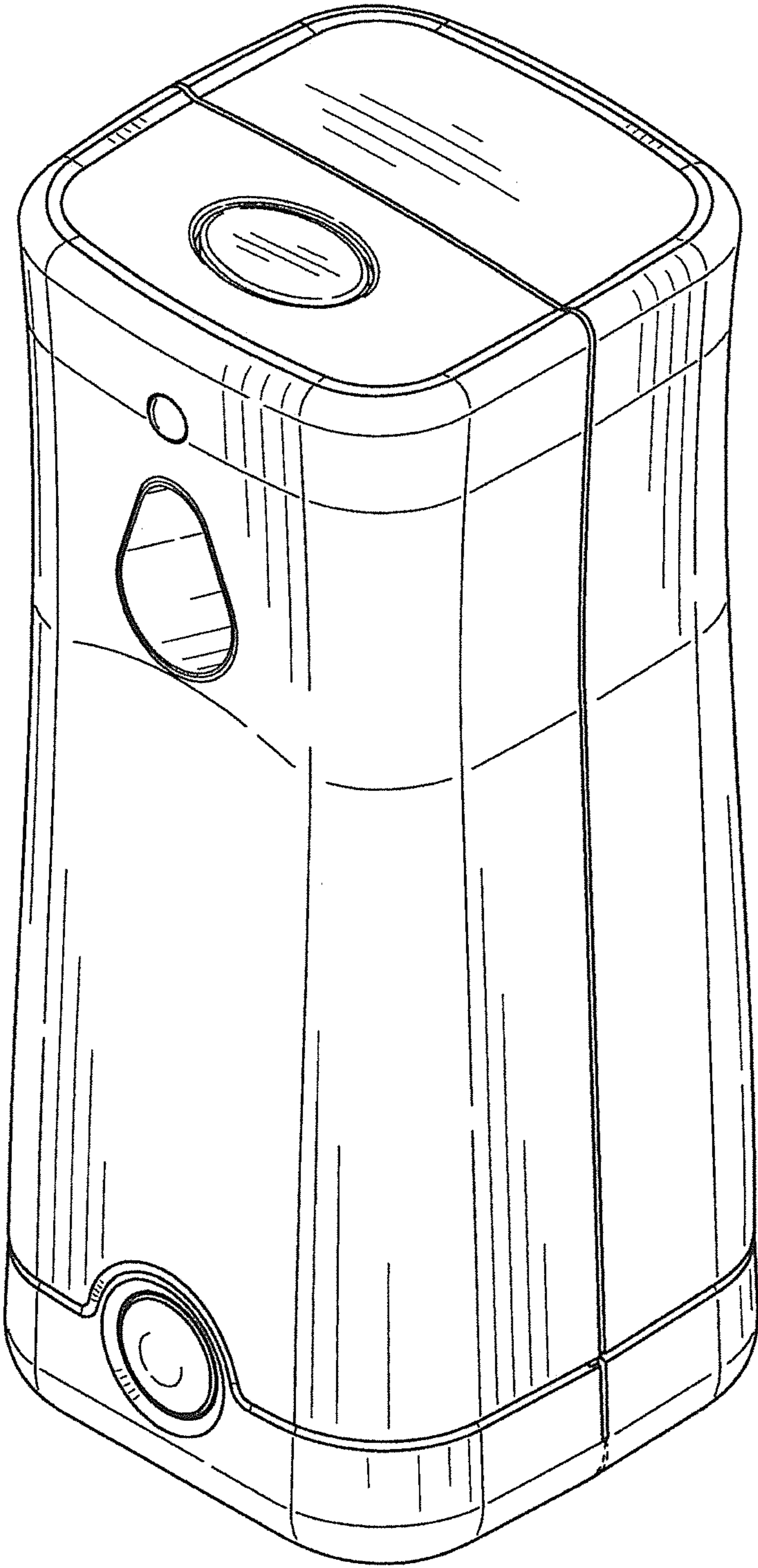


FIG. 1



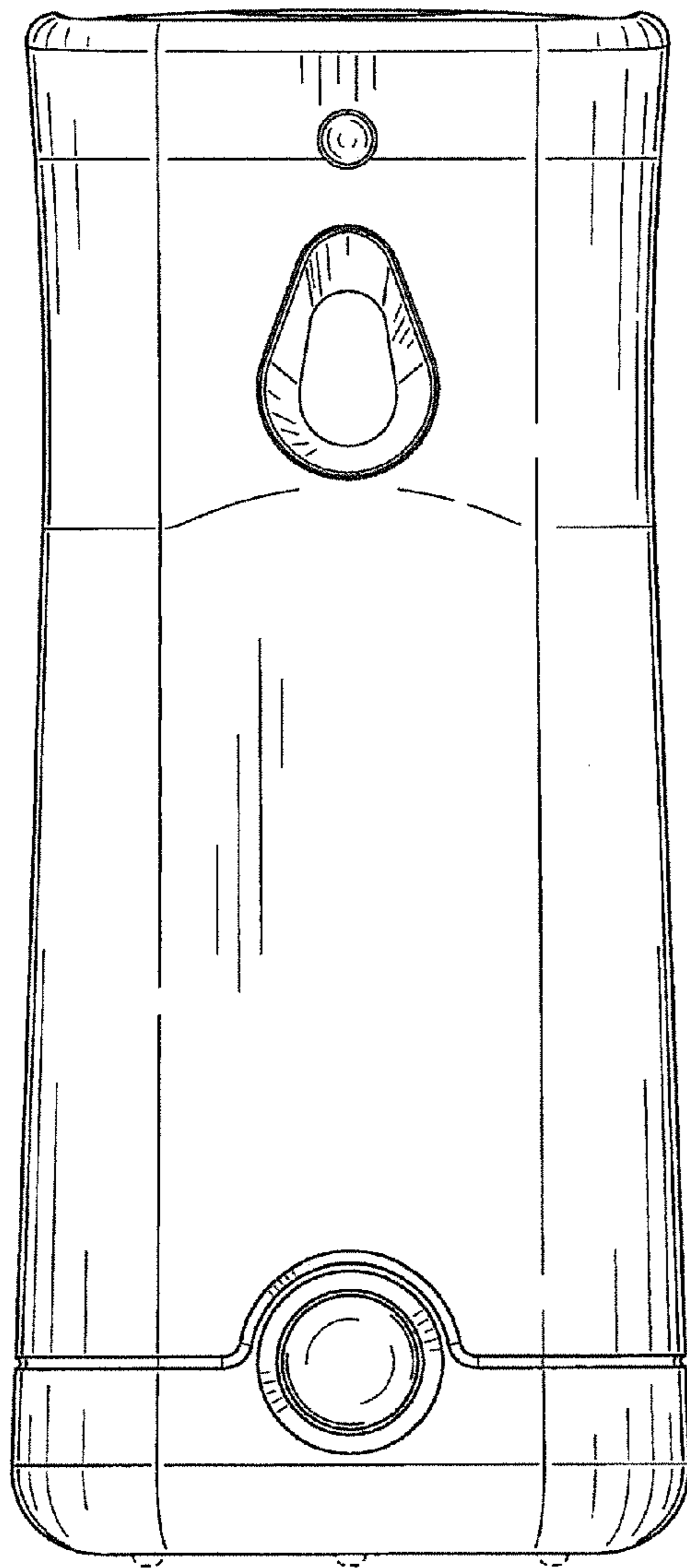


FIG. 2

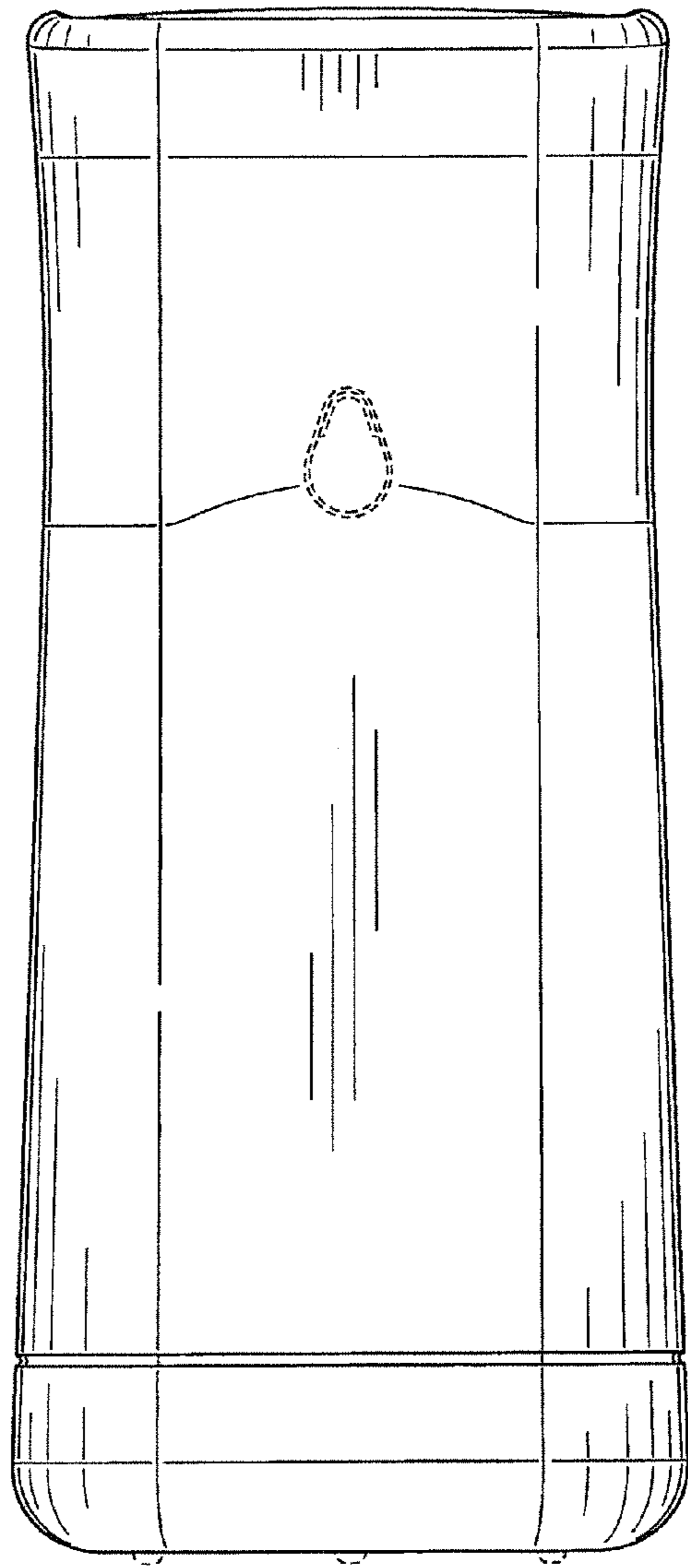


FIG. 3

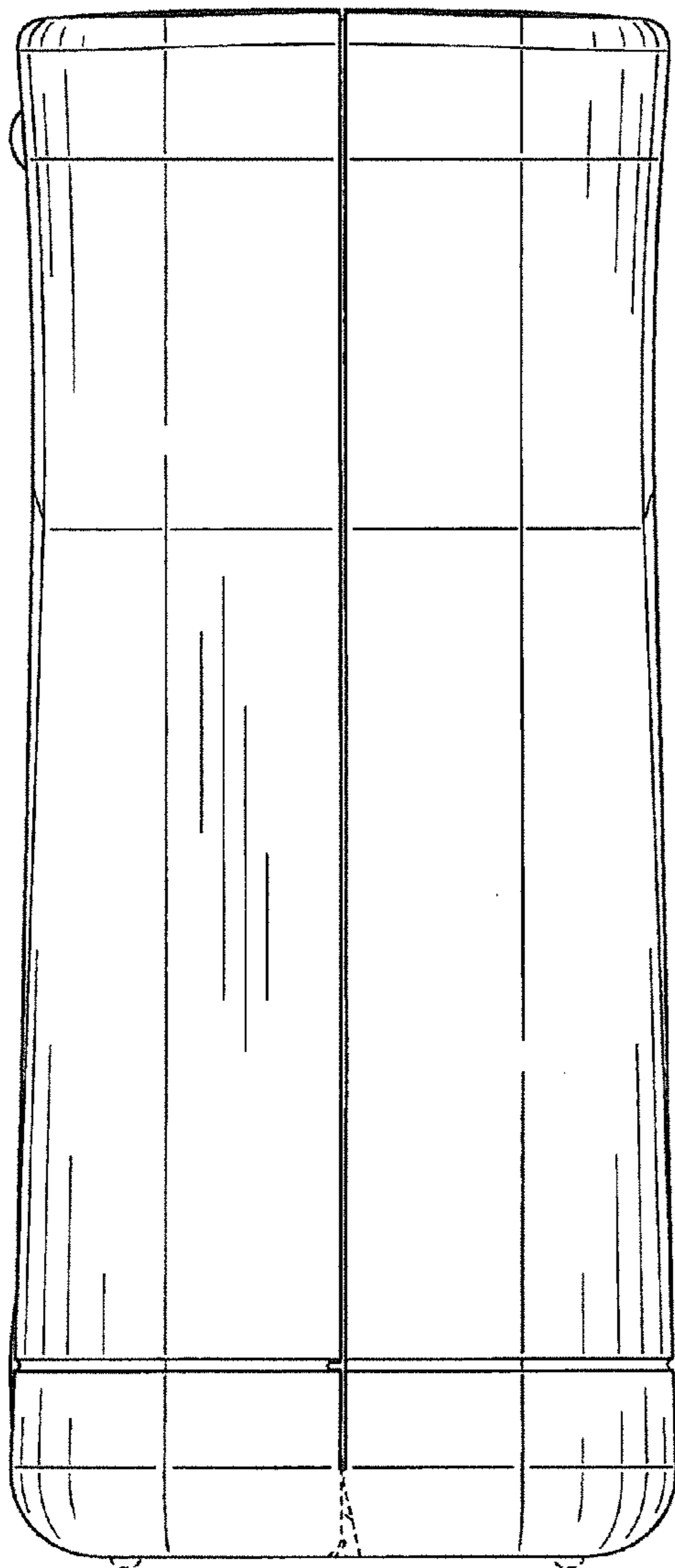


FIG. 4

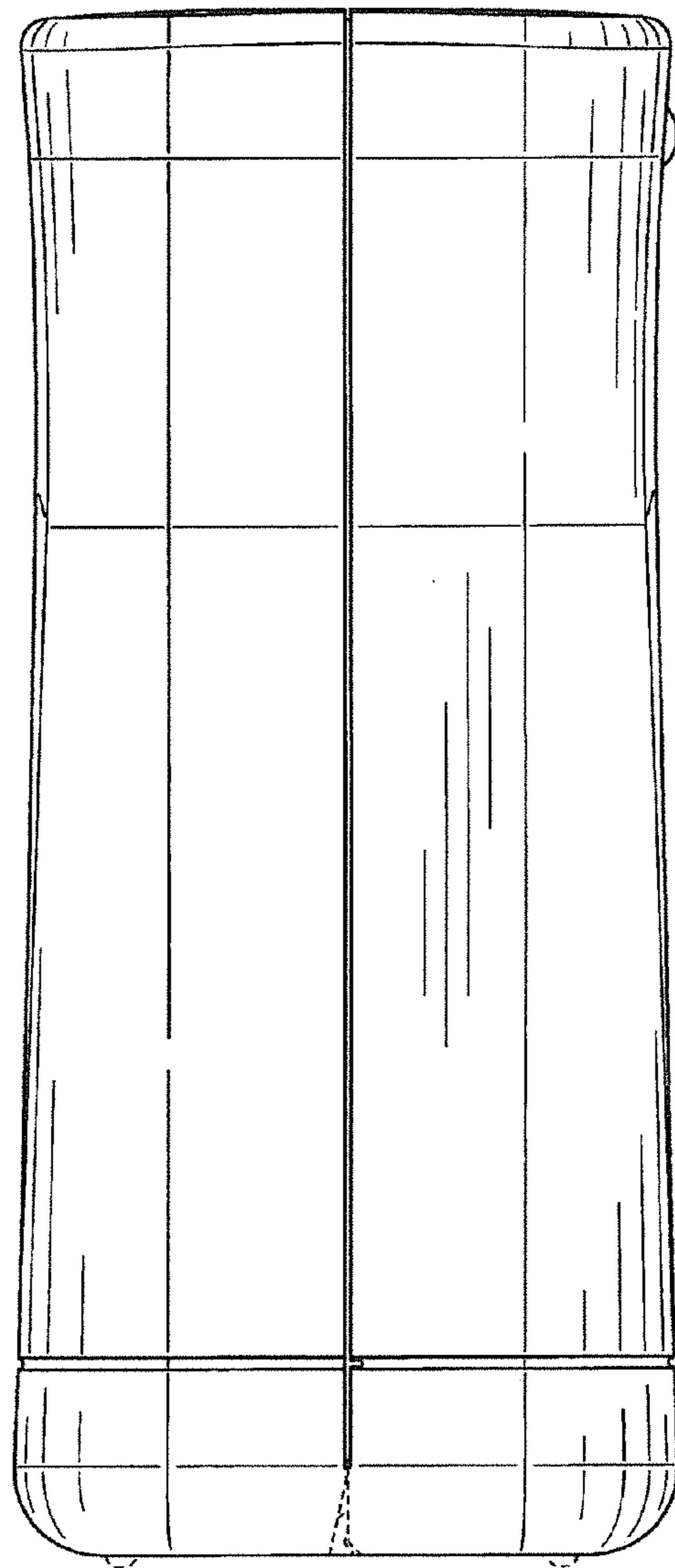


FIG. 5

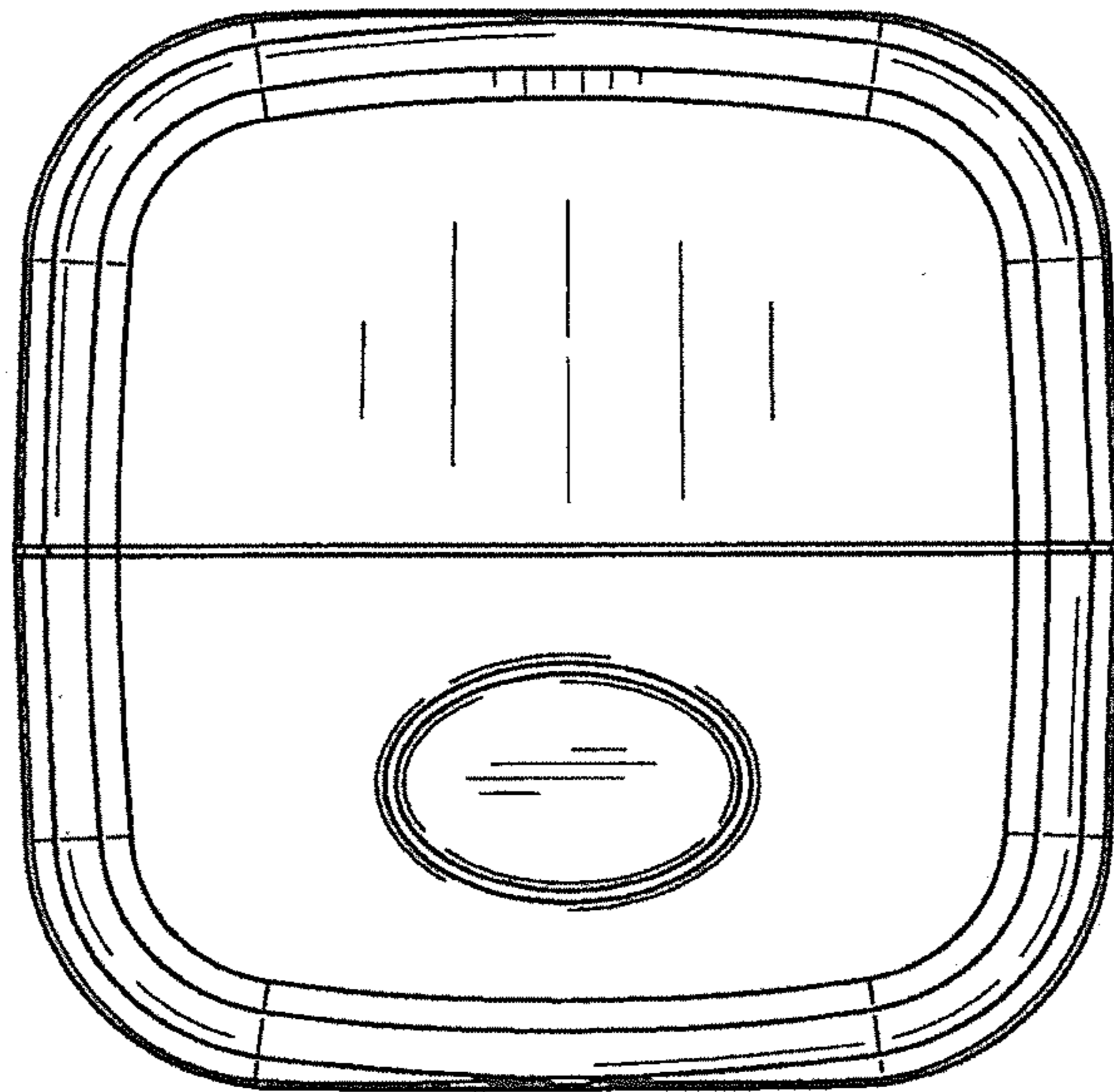


FIG. 6

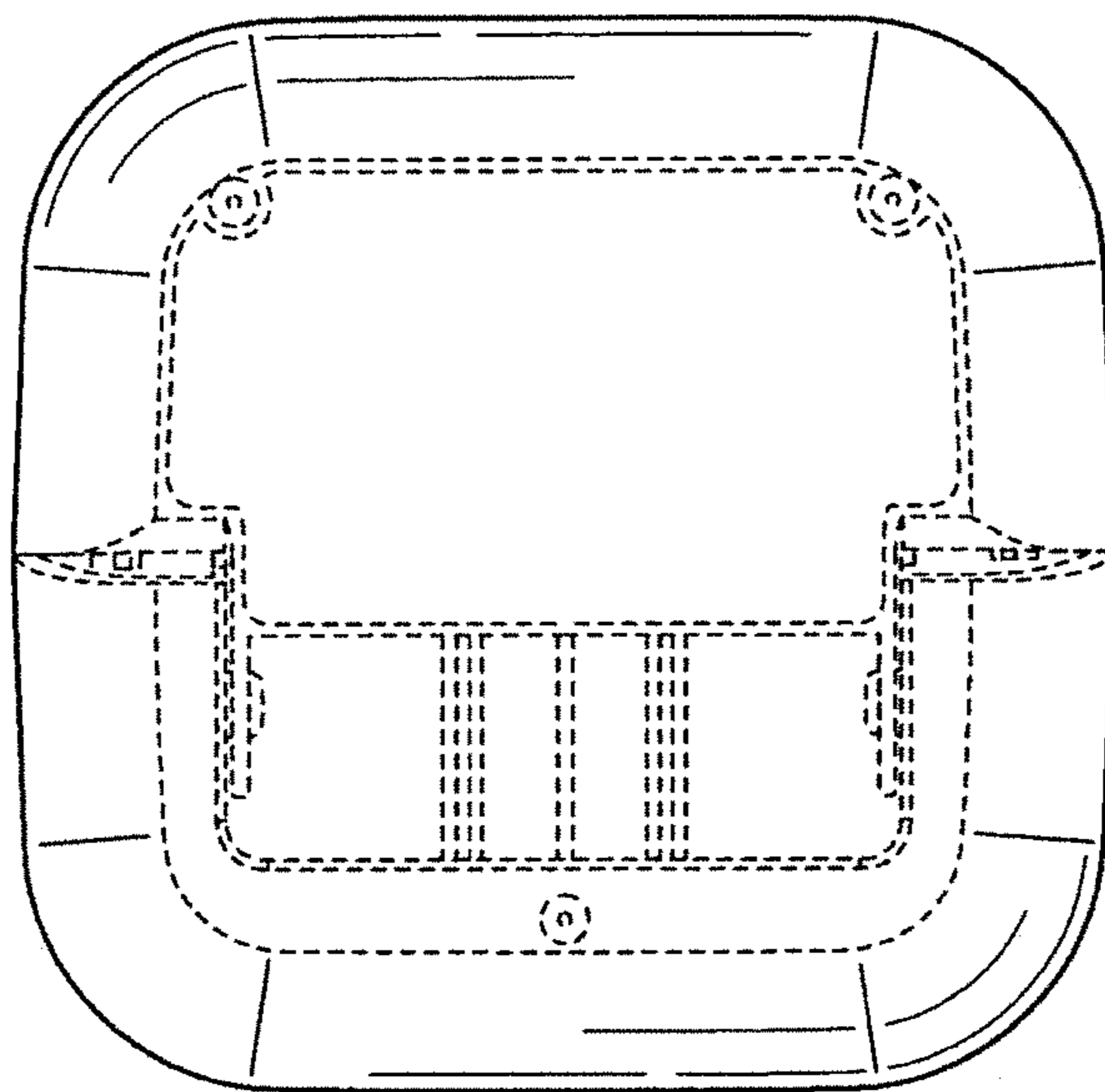


FIG. 7

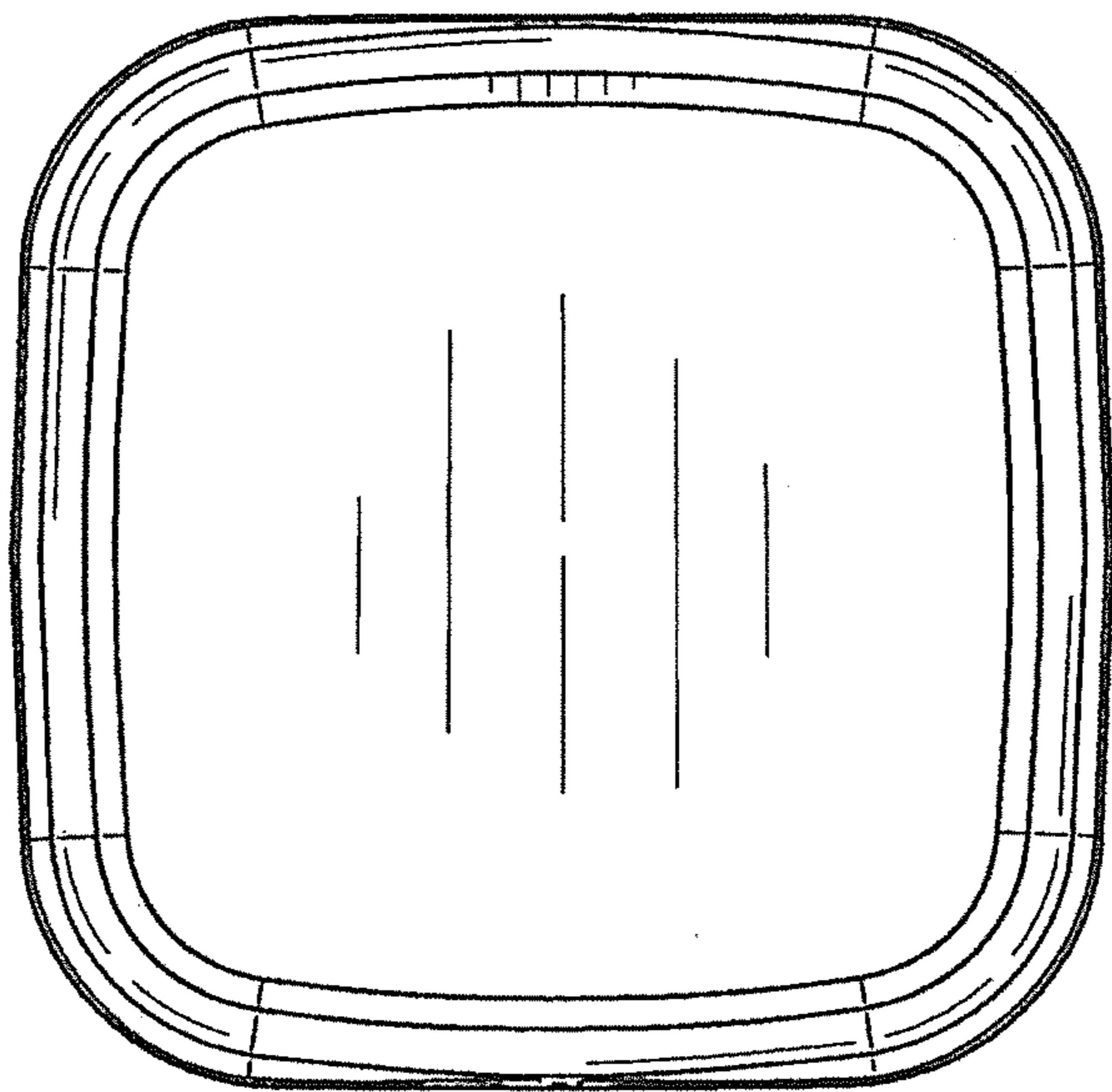


FIG. 8